

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S4	645237	implant\$ or dop\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/22 08:32
S5	8320636	(viahole or opening or aperture or trench or hole or via)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/22 11:39
S6	1430862	hydrogen or h2 or "h.sub.2"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/22 11:41
S8	15115	S4 with S6	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/21 14:26
S9	721	S8 with S5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/21 14:29
S10	540	S9 and @ad<"20030401"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/22 08:11
S14	3021723	ch3 or "ch.sub.3" or ch	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/02/22 08:42
S15	2233314	dielectric or insulat\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/22 08:43
S16	9880	S14 with S15	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/22 08:43
S17	516	S16 with (treat\$4 or expos\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/22 08:45
S18	153	S17 and @ad<"20031010"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/21 14:42

S19	2	"6790774".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/22 10:05
S20	3	((("20020022365") or ("6538324") or ("6333248")).PN.	US-PGPUB; USPAT	OR	OFF	2006/02/22 10:08
S21	4	((("20020022365") or ("6645852") or ("6538324") or ("6333248")).PN.	US-PGPUB; USPAT	OR	OFF	2006/02/22 11:00
S22	11	((("20050095751") or ("20050054195") or ("20040166676") or ("20030194857") or ("20030104692") or ("20010053592") or ("6861349") or ("6833321") or ("6703307") or ("6642146") or ("5990011")).PN.	US-PGPUB; USPAT	OR	OFF	2006/02/22 13:14
S23	6190	implant\$7 with barrier	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/22 11:38
S24	1637	S23 and (copper or tungsten or cu)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/22 11:38
S25	1329	S24 and (damascene or viahole or opening or aperture or trench or hole or via)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/22 11:40
S26	136	S24 and (damascene)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/22 11:39
S27	635	S25 and (stop\$4 or etchstop\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/22 11:40
S28	1430862	hydrogen or h2 or "h.sub.2"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/22 11:42
S29	307	S27 and S28	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/22 11:55
S30	192	S29 and (semiconductor or (semi adj1 conductor))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/22 12:26
S32	32	10/682196	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/21 09:27

S33	2	("6318124").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/21 09:52
S34	2	("5554570").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/21 09:52
S35	2	"770114".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/21 14:43
S36	2	"20010019857"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/21 14:43
S37	411	(hsq or hydrogensilsesquioxane or (hydrogen adj1 silsesquioxane)) near4 (dielectric near3 constant)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/23 08:22
S38	683	(hsq or hydrogensilsesquioxane or (hydrogen adj1 silsesquioxane)) with (porous or nonporous)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/23 08:37
S39	68	(hsq or hydrogensilsesquioxane or (hydrogen adj1 silsesquioxane)) with (hybrid)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/23 08:38
S40	0	S39 and "20010019857"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/23 10:08
S41	29196	supercritical or (super adj1 critical)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/23 10:09
S42	2	("6318124").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/23 10:09
S43	2	"20010019857"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/23 10:09
S44	4	S42 or S43	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/23 10:09

S45	0	S44 and S41	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/23 10:10
S46	32	10/682196 and S41	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/23 10:13
S47	393881	"co.sub.2" or (carbon adj1 dioxide) or (carbon adj1 di-oxide)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/23 10:14
S48	10763	S41 with S47	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/23 10:14
S49	1826013	semiconductor or (semi adj1 conductor)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/23 10:15
S50	1908	S48 and S49	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/23 10:15
S51	717	(dielectric or insulat\$4 or film or layer) with S48	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/23 10:16
S52	394	S51 and S49	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/23 10:16
S53	229	S52 and @ad<"20031010"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/25 06:47
S54	0	(11/009575).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/25 06:48
S55	1	11/009575	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/25 20:20
S56	1	10/195527	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/25 20:27

S57	1	10/976376	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/25 20:30
S58	2	"6746591"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/25 20:33
S59	1	11/096515	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/27 07:55
S60	6	"6274429"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/27 09:40
S61	1	10/976376	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/27 09:40
S62	2	"5679606".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/07/26 08:56
S63	2	"6033981".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/07/26 09:14
S64	1	10/784186	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/07/26 09:15
S65	1	S64 and situ	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/07/26 09:15
S66	1069	tmcts or omcts	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/02/13 15:13
S68	5	10/682196 and S66	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/02/13 15:13
S69	7338	tetramethylcyclotetrasiloxane or octamethylcyclotetrasiloxane	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/13 15:20

S70	7712	S66 or S69	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/13 15:21
S71	1540	S70 and (semiconductor or (semi adj1 conductor))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/13 15:21
S72	912	S71 and @ad<"20031010"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/13 15:22
S73	1	11/175582	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/13 15:39
S74	2	"5440161".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/13 15:47
S75	1069	tmcts or omcts	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/02/13 22:06
S76	7338	tetramethylcyclotetrasiloxane or octamethylcyclotetrasiloxane	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/13 22:06
S77	7712	S75 or S76	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/13 22:06
S78	1540	S77 and (semiconductor or (semi adj1 conductor))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/13 22:06
S79	912	S78 and @ad<"20031010"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/13 22:06
S80	652	S79 AND (OPENING OR VIA OR HOLE OR VIAHOLE OR APERTURE OR TRENCH)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/13 22:06
S81	1071	tmcts or omcts	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/02/14 15:13

S82	7345	tetramethylcyclotetrasiloxane or octamethylcyclotetrasiloxane	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/14 15:13
S83	7719	S81 or S82	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/14 15:13
S84	521	S83 with (n2 or nitrogen or cl2 or chlori\$4 or "n.sub.2" or "cl.sub.2")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/14 15:14
S85	385	S84 and @ad<"20031010"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/14 15:15
S86	1071	tmcts or omcts	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/02/14 21:38
S87	7345	tetramethylcyclotetrasiloxane or octamethylcyclotetrasiloxane	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/14 21:38
S88	7719	S86 or S87	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/14 21:38
S89	521	S88 with (n2 or nitrogen or cl2 or chlori\$4 or "n.sub.2" or "cl.sub.2")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/14 21:38
S90	385	S89 and @ad<"20031010"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/14 21:38
S91	86	S90 and (semiconductor or (semi adj1 conductor))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/14 21:38
S92	385	S89 and @ad<"20031010"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/14 23:36
S93	1071	tmcts or omcts	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/02/14 23:36

S94	7345	tetramethylcyclotetrasiloxane or octamethylcyclotetrasiloxane	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/14 23:36
S95	7719	S93 or S94	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/14 23:36
S96	1544	S95 and (semiconductor or (semi adj1 conductor))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/14 23:36
S97	912	S96 and @ad<"20031010"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/14 23:36
S98	652	S97 AND (OPENING OR VIA OR HOLE OR VIAHOLE OR APERTURE OR TRENCH)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/14 23:36
S99	49	10/682196	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/09/22 09:59
S100	35	S99 and plasma\$	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/22 10:11
S101	8	S99 and (tmcts or omcts)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/22 10:21
S102	2	("20030089988").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/09/22 10:55
S104	8137	TMCTS or tetramethylcyclotetrasiloxane or OMCTS or octamethylcyclotetrasiloxane	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/09/22 11:03
S105	5240	S104 and @ad<"20031010"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/22 11:05
S106	919	S105 and (semiconductor or (semi adj1 conductor))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/22 11:06



S107	636	S104 with (treat\$5 or expos\$4 or wash\$4 or clean\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/22 13:28
S108	109	S107 and (semiconductor or (semi adj1 conductor))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/22 13:29
S109	109	S108 and (semiconductor or (semi adj1 conductor))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/22 13:29
S110	55	S108 and @ad<"20031010"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/22 13:29
S111	222693	sic or (silicon adj1 (carbon or carbide))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/22 14:51
S112	216	S104 same S111	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/22 14:52
S113	96	S112 and @ad<"20031010"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/22 14:59
S114	59	S113 and (semiconductor or (semi adj1 conductor))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/22 15:00
S115	2	"20030089988".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/22 15:55
S116	4	((("6318124") or ("20010019857")).PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/09/22 16:00
S119	21095	((257/328-334) or (257/296-310) or (438/257-267)).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/09/22 23:50
S120	881664	isolation or fox or sti or (field near1 oxide)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/09/22 23:53

S121	11245	S119 and S120	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/09/22 23:54
S122	3513	S121 and ((gate or electrode) near2 (trench or opening or via or viahole or aperture))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/22 23:55
S123	3181	S122 and @ad<"20060609"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/22 23:55
S124	1	11/450096	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/23 15:29
S125	1	11/143025	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/23 15:39
S126	2	("20040087078").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/09/23 15:56
S127	2	("6930299").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/09/23 21:34
S128	2	("6660587").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/01/22 14:32
S129	191	(US-20040166676-\$ or US-20060006548-\$ or US-20060024849-\$ or US-20050029117-\$ or US-20030211312-\$ or US-20040041267-\$ or US-20020098684-\$ or US-20050010000-\$ or US-20020015800-\$ or US-20040053459-\$ or US-20040046190-\$ or US-20040043597-\$ or US-20040137756-\$ or US-20010019857-\$ or US-20030118796-\$ or US-20020018152-\$ or US-20050077597-\$ or US-20050215072-\$ or US-20020055275-\$ or US-20020187627-\$ or US-20020140003-\$ or US-20050032352-\$ or US-20040166445-\$ or US-20040053498-\$ or US-20040099952-\$ or US-20040224865-\$). did. or (US-20040185656-\$ or US-20040180299-\$ or US-20040176488-\$ or US-20040175958-\$ or US-20040134885-\$ or US-20040118812-\$ or US-20040018452-\$ or US-20020020946-\$ or US-20040038155-\$ or US-20030236003-\$ or US-	US-PGPUB; USPAT; DERWENT	OR	OFF	2009/01/22 14:42

20030040192-\$ or US-20060110610-\$ or  
US-20060040110-\$ or US-20050064698-\$  
or US-20050059245-\$ or US-  
20050048772-\$ or US-20050048731-\$ or  
US-20050037153-\$ or US-20040253378-\$  
or US-20040241342-\$ or US-  
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US-20040132287-\$ or US-20040101633-\$  
or US-20040083964-\$ or US-  
20040082199-\$ or US-20040067308-\$).  
did. or (US-20040061176-\$ or US-  
20040018735-\$ or US-20030211244-\$ or  
US-20030176058-\$ or US-20030162410-\$  
or US-20030113995-\$ or US-  
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or US-20040078152-\$ or US-  
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or US-20070138523-\$ or US-  
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US-20070057303-\$ or US-20070040202-\$  
or US-20070040201-\$ or US-  
20070012992-\$ or US-20060237783-\$ or  
US-20060197132-\$ or US-20050247966-\$  
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6479407-\$ or US-6555450-\$ or US-  
6025273-\$ or US-6717236-\$ or US-  
6703273-\$ or US-6690071-\$ or US-  
6673721-\$ or US-6218206-\$ or US-  
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6515368-\$ or US-4956314-\$ or US-  
6831018-\$ or US-6713382-\$ or US-  
6171951-\$ or US-6638850-\$ or US-  
6638848-\$).did. or (US-6998343-\$ or US-  
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7060330-\$ or US-6913992-\$ or US-  
6890850-\$ or US-6806203-\$ or US-  
6797643-\$ or US-6784119-\$ or US-  
6737746-\$ or US-6657304-\$ or US-

		6541842-\$ or US-6465345-\$ or US-5990557-\$ or US-5691573-\$ or US-6890605-\$ or US-6884318-\$ or US-6870123-\$ or US-6770570-\$).did. or (US-6749944-\$ or US-6677549-\$ or US-6378337-\$ or US-5869406-\$ or US-5593741-\$ or US-5290736-\$ or US-5231058-\$ or US-7345000-\$ or US-6100181-\$ or US-6759327-\$ or US-6627532-\$ or US-7425740-\$ or US-7414278-\$ or US-7358556-\$ or US-7309890-\$ or US-7250342-\$ or US-7211864-\$ or US-7157763-\$ or US-7094644-\$ or US-7087956-\$ or US-7084457-\$ or US-7045846-\$ or US-7030440-\$ or US-6995415-\$ or US-6727539-\$ or US-6177697-\$).did. or (KR-9502955-\$ or US-6391658-\$ or US-6291295-\$ or TW-441002-\$ or JP-2000164704-\$ or US-20040175958-\$).did.				
S130	51	10/682196	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/01/22 14:45
S131	12	S130 and (cl or "cl.sub.2" or chlori\$5)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/01/22 14:47
S132	3558524	(cl or "cl.sub.2" or chlori\$5)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/01/22 14:52
S133	1248	tmcts or omcts	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/01/22 14:54
S134	8065	tetramethylcyclotetrasiloxane or octamethylcyclotetrasiloxane	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/22 14:54
S135	8474	S133 or S134	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/22 14:54
S136	8467	TMCTS or tetramethylcyclotetrasiloxane or OMCTS or octamethylcyclotetrasiloxane	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/01/22 14:55
S137	5275	S136 and S132	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/01/22 14:56

S138	3115	S137 and @ad<"20031010"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/22 14:56
S139	387	S138 and (semiconductor or (semi adj1 conductor))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/22 14:57

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